- Designed for GSM BTS Transmitter IF Applications
- Low Insertion Loss
- Excellent Size-to-Performance Ratio
- Hermetic $13.3 \times 6.5 \mathrm{~mm}$ Surface-Mount Case
- Unbalanced Input and Output
- Complies with Directive 2002/95/EC (RoHS)



## SF1086A

## 125 MHz SAW Filter



SM13365-12

## Electrical Characteristics

| Characteristic | Sym | Notes | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Nominal Center Frequency | ${ }^{\text {f }}$ | 1 | 125.000 |  |  | MHz |
| Insertion Loss at fc1 dB PassbandAmplitude Ripple over fc $\pm 150 \mathrm{kHz}$Group Delay Variation over fc $\pm 150 \mathrm{kHz}$Absolute Group Delay | IL |  |  | 6 | 8.0 | dB |
|  | $\mathrm{BW}_{1}$ | 1, 2 | $\pm 150$ | $\pm 205$ |  |  |
|  |  |  |  |  | 1.25 | kHz |
|  | GDV |  |  | <100 | 150 | $n S_{\text {P-P }}$ |
|  | GD |  | 0.7 | 1.2 | 1.7 | $\mu \mathrm{s}$ |
| Rejectionfc-0.6 to fc-0.4 and fc +0.4 to fc +0.6 MHz <br> $\mathrm{fc}-1.2$ to fc-0.6 and fc +0.6 to fc +1.2 MHz <br> $\mathrm{fc}-1.8$ to fc-1.2 and fc +1.2 to fc +1.8 MHz <br> $\mathrm{fc}-3.4$ to fc-1.8 and fc +1.8 to fc +3.4 MHz <br> $\mathrm{fc}-9.5$ to fc-3.4 and fc +3.4 to fc +9.5 MHz <br> fc-13 to fc-9.5 and fc +9.5 to fc +13 MHz <br> DC to fc-13 and fc +13 to 450 MHz <br> Except Spurious Rejection near 1.6, 1.8, and $2.0 \times \mathrm{fc}$ |  | 1, 2, 3 | 2 |  |  | dB |
|  |  |  | 8 |  |  |  |
|  |  |  | 20 | 23 |  |  |
|  |  |  | 25 | 37 |  |  |
|  |  |  | 30 | 47 |  |  |
|  |  |  | 43 | 65 |  |  |
|  |  |  | 55 | >60 |  |  |
|  |  |  | 50 |  |  |  |
| Operating Temperature Range | $\mathrm{T}_{\text {A }}$ | 1 | -10 |  | +85 | ${ }^{\circ} \mathrm{C}$ |


| Impedance Matching to $50 \Omega$ unbalanced | External L-C |
| :--- | :---: |
| Case Style | SM13365-12 $13.3 \times 6.5 \mathrm{~mm}$ Nominal Footprint |
| Lid Symbolization (YY = year, WW = week) | RFM SF1086A YYWW |

## Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 W and measured with $50 \Omega$ network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. Electrostatic Sensitive Device. Observe precautions for handling.

## Electrical Connections

| Connection | Terminals |
| :--- | :---: |
| Port 1 Hot | 11 |
| Port 1 Gnd Return | 12 |
| Port 2 Hot | 5 |
| Port 2 Gnd Return | 6 |
| Case Ground | All others |




## SM13365-12 Case

## 12-Terminal Ceramic Surface-Mount Case <br> $13.3 \times 6.5$ mm Nominal Footprint



| Case Dimensions |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimension | mm |  |  | Inches |  |  |  |
|  | Min | Nom | Max | Min | Nom | Max |  |
| A | 13.08 | 13.31 | 13.60 | 0.515 | 0.524 | 0.535 |  |
| B | 6.27 | 6.50 | 6.80 | 0.247 | 0.256 | 0.268 |  |
| C |  | 1.91 | 2.00 |  | 0.075 | 0.079 |  |
| D |  | 1.50 |  |  | 0.059 |  |  |
| E |  | 0.79 |  |  | 0.031 |  |  |
| H |  | 1.0 |  |  | 0.039 |  |  |
| P |  | 2.54 |  |  | 0.100 |  |  |


| Materials |  |
| :--- | :--- |
| Solder Pad <br> Termination | Au plating 30-60 $\mu$ inches $(76.2-152 ~$ m ) over 80- |
| $200 \mu$ inches $(203-508 \mu \mathrm{~m}) \mathrm{Ni}$. |  |$|$| Lid | Fe-Ni-Co Alloy Electroless Nickel Plate (8-11\% <br> Phosphorus) $100-200$ inches Thick |
| :--- | :--- |
| Body | $\mathrm{Al}_{2} \mathrm{O}_{3}$ Ceramic |
| Pb Free |  |


| Clectrical Connections |  |  |
| :--- | :--- | :---: |
| Connection |  | Terminals |
| Port 1 | Input or Return | 2 |
|  | Return or Input | 3 |
| Port 2 | Output or Return | 8 |
|  | Return or Output | 9 |
|  | Ground | All others |
| Single Ended Operation |  | Return is ground |
| Differential Operation |  | Return is hot |



3. LABEL FIXTURE WITH ELECTRONIC METHOD AS SHOWN.
4. SOLDER $\mathrm{J} 1 \& 2$ TO PCB AS SHOWN.

$\square$ B
2

$\square$

SF 1086 A (DEMO), TM. ., $3-30-98$, AC\# 9812 30 Mar 1998 13:15:28



## BILL OF MATERIALS

PART IDENTIFIER
SF1086A-DEMO
SF1086A-000
400-0735-001
400-0533-001
500-0003-330
500-0248-001
500-0010-221
500-0010-271
500-0010-270
500-0010-330

DESCRIPTION 1
DEMO BOARD,SF1086A
ASSY DIAGRAM,DEMO BOARD,
PCB,DEMO BOARD,13.3 X 6.5
SHIELD,TO-39 TEST FIXTURE
CAP,CHIP,NPO,33(J),STD
CONN,COAX,FLANGE MT.JACK IND,CHIP,1008CS,220NH,10\% IND,CHIP,1008CS,270NH,10\% IND,CHIP,1008CS,27NH,10\%

IND,CHIP,1008CS,33NH,10\%

DESCRIPTION 2
QTY/ASSY
REFERENCE DESCRIPTION

SF1086A
4 HOLE
1.0000 PCB
1.0000 SHLD1
2.0000 C 1,2
2.0000 J 1,2
1.0000 L 1
1.0000 L 2
1.0000 L 3
1.0000 L 4

| REV | ECN | DATE |  |
| :---: | :---: | :---: | :--- |
| A | 6713 | $05 / 08 / 98$ | INITIAL RELEASE |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |


| $\\|^{11}$ | SIZE <br> A | FSCM NO. 2U874 | DWG NO.SF1086A-DEMO |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SCALE NONE | W/O or ECN | 6713 | REV A | SHEET | 2 | OF | 2 |

